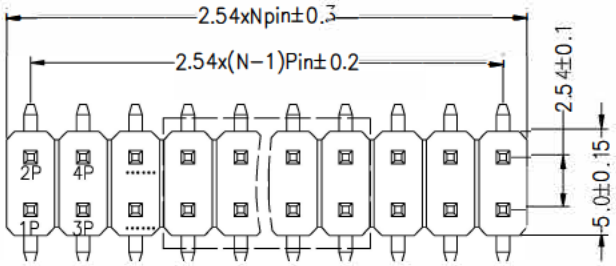
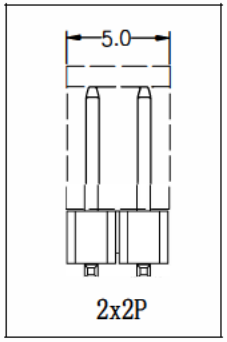
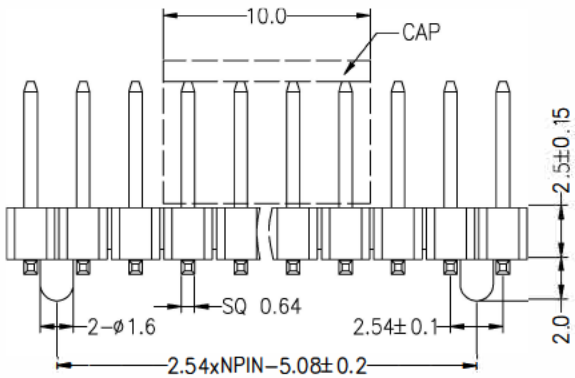
HSF RoHS

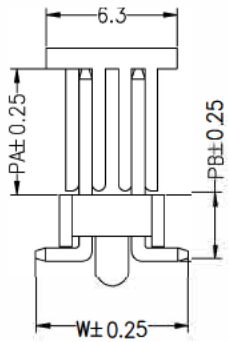
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 5 seconds)

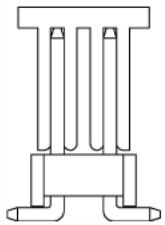




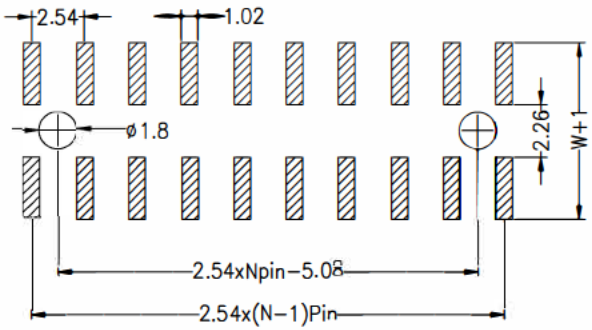




W=With Post



N=W/O Post



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

Dimension antitheses list			
ITEM	PA	PB	W
Alternate	6.00	3.20	7.50

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.11.12	NEW DRAWING	

OPERATION				
X.X	±0.30	DRAW	ChenWei	21.11.12
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

PART NO. IE-JL-1225-PHS-DV-04-CNG0110-R

TITLE: 2.54PH 2xNpin H2.5mm SMT